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# **Overview**

- The LHCb Muon Detector
- Requirements
- Performances:
  - Detection Efficiency and time resolution
  - Ageing studies
- Production status
- Conclusions

# **The LHCb Muon Detector**



- 5 muon stations, one upstream (M1), 4 downstream (M2-M5) the calorimeters.
- Each station is divided in 4 Radial Regions R1,R2,R3,R4
- The muon detector must provide high-pt information to the Level-0 muon trigger through a coincidence of hits in all five stations within the bunch crossing time of 25 ns
- The muon momentum must be measured with  $\delta p_t/p_t \sim 20\%$  accuracy.

The LHCb muon detecto



- 1380 MWPC chambers, total surface: 435 m<sup>2</sup>
- **12** triple GEM detectors for the highest rate region
- Dimensions scales according to a pointing geometry
- M2-M5: 4-gaps, M1: 2-gap

# **Rates and Readout**

	M1	M2	M3	M4	M5	]
R1	460 GEM	37.5 MWPC mixed r/o	10 MWPC mixed r/o	6.5 MWPC cathode r/o	4.4 MWPC cathode r/o	Rates (KHz) Detector type Readout
R2	186 MWPC	26.5 MWPC mixed r/o	3.3 MWPC mixed r/o	2.2 MWPC cathode r/o	1.8 MWPC cathode r/o	
R3	80 MWPC cathode r/o	6.5 MWPC cathode r/o	1.0 MWPC cathode r/o	0.75 MWPC cathode r/o	0.65 MWPC cathode r/o	
R4	25 MWPC wires r/o	1.2 MWPC wires r/o	0.4 MWPC wires r/o	0.25 MWPC wires r/o	0.23 MWPC wires r/o	

#### Expected rates considering $\sigma_{pp}$ = 102.4 mb including safety factors

# Requirements

- High detection efficiency (> 99%) per station in a 20 ns time window:
  - $\rightarrow$  good time resolution
- Good rate capability: up to ~460 kHz/cm<sup>2</sup> @ L = 5•10<sup>32</sup> cm<sup>-2</sup> s<sup>-1</sup> in hottest region; → fast
- Aging resistant: up to an integrated charge ~ 1 C/cm for safe operation in 10 years @ <L> = 2•10<sup>32</sup> cm<sup>-2</sup> s<sup>-1</sup> → robust

# **MWPC** design

- 4 wire layers (High detection efficiency + redundancy)
- 5 mm symmetric gas gap
- 2 mm wire pitch (gold plated tungsten wires, 30 μm diameter)
- Wire tension: > 50 g



# **MWPC** operating parameters:

- Ar / C0<sub>2</sub> / CF<sub>4</sub> (40:40:20) Gas mixture:
- Working point: Gain~ 5•10<sup>4</sup>
- total charge per gap: 53 e<sup>-</sup> (gap 5.0 mm)

Total charge per mip: 0.4 pC (for cathode pads readout)

- Field on wires: 212 kV/cm, field on cathodes: ~ 5 kV/cm
- Drift volocity: ~ 90 μm/ ns \_\_\_\_ collecting time @ half wire pitch: ~ 10 ns



# **MWPC readout schemes**

- The readout scheme depends on the granularity requested by: trigger, offline and particle rate
- We have: anode wire readout, cathode pads readout and combined readout (anode wire + cathode pads)





#### R1/R2-M2/M3: mixed readout



Granularity goes from (1x2.5)cm<sup>2</sup> to (25x30) cm<sup>2</sup> MWPC dimensions from (48x20)cm<sup>2</sup> to (149x31)cm<sup>2</sup>

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# A small MWPC prototype:



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~ 15 prototypes built and tested with (almost) final front-end electronics at the T11 test beam area at CERN.

## The Front-End Electronics: the CARIOCA chip

Carioca is the Amplifier-Shaper-Discriminator front-end chip developed for the MWPCs of LHCb

Specifications important for time resolution and rate capability:

- Sensitivity: 15mV/fC
- Short peaking time: tp ~ 10 ns for Cdet = (40÷220) pF
- Low noise:

ENC ~ 2000 e-/pF

• High rate capability:

pulse width ~ 50 ns, signal tail cancellation and baseline restoration circuits.

• 8 amplifiers per chip – 2 chips per board



### **Efficiency and time resolution**



## **Time Resolution and Efficiency Uniformity:**

Example of uniformity measurements on a M3R3 prototype with cathode pad readout



#### >99% pads are inside the specifications

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### **High Rate behavior**



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## **Aging Test of MWPCs**

# Expected Integrated charge in 10 years @ 2•10<sup>32</sup> cm<sup>-2</sup> s<sup>-1</sup>



- Q < 10 mC/cm for 76% of area
- 10 mC/cm <Q < 100 mC/cm for 19% of area
- 100 mC/cm < Q < 1 C/cm for 5% of area

Particle rates are from LHCb-Muon TDR2001.

Safety factors of have been included to take into account the deposited charge of low energy background hits.

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### Aging tests @ ENEA Casaccia Calliope Facility:

- Source: <sup>60</sup>Co (~ 10<sup>15</sup> Bq)
  <Eγ> ~ 1.25 MeV
- 3 MWPC irradiated with dose rates up to ~ 0.3 Gy/hr and different gas flows (vented and re-circulating gas system)
- Standard mixture: Ar / C0<sub>2</sub> / CF<sub>4</sub> = 40:40:20
- Gas gain ~ (1÷1.5) 10<sup>5</sup> (~double wrt to the nominal one).



## Aging tests @ ENEA Casaccia Calliope Facility

- 32 days of tests
- Integrated charge per cm of wire:

**Q** ~ (440÷480) mC/cm  $\Rightarrow$  (5÷10) years depending on the rate evaluation.

- Typical current density:  $I \sim (1 \div 1.4) \mu A/cm^2$  (active areas = 500÷1200 cm<sup>2</sup>);
- In each chamber, one gap (out of 4) was switched on only for short periods to be used as reference



#### **Integrated Charge:**

# Aging tests @ ENEA Casaccia Calliope Facility

We normalized the currents of tested gaps respect to the reference gap in order to remove T and P dependence and accidental gas mixture changes.

#### $\Rightarrow$ Current ratios are constant within ~10% for all chambers.



Malter currents: The self-sustaining rest currents were measured with the source off, using current monitors with a resolution of 1 nA.

⇒ All gaps of all chambers drew currents of the order of few tens of nA or smaller with a decreasing trend.

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# **Analysis of Wires**



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# **Etching of the FR4 frame:**

The FR4 is etched also where there is no electric field. This effect is visible also in the reference gap : → due to ionized gas fluorine etching.

**Boundary of FR4 etching** 

#### The etching of the FR4 frame goes with the gas flow :

Gas flow direction:  $B1 \Rightarrow B2 \Rightarrow A2 \Rightarrow A1$ , B1=reference gap



### **Conclusions on the MWPC ageing test**

In 32 days we integrated up to Q~480 mC/cm corresponding to 5÷10 years (depending on the rates foreseen) of LHCb
 2 x 10<sup>32</sup> cm<sup>-2</sup> s<sup>-1</sup>

• Materials exposed to  $CF_4$  under irradiation show a surface etching BUT no drop in gas gain observed within 10%:

 $\Rightarrow$  we decided do not change chamber design and materials

# **MWPC Chamber Production**

- A total of 1380 MWPC (+ 10% spare) have to be produced
- The MWPC are produced in 6 productions centers:
  - LNF, Ferrara, Firenze, CERN, PNPI-1,PNPI-2
- LNF,PNPI-1,CERN started in January 2004, Ferrara and Firenze in August 2004, PNPI-2 is starting now







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# Conclusions

• Three years of extensive tests showed that our design of MWPCs of operating with  $CF_4$  based gas mixture satisfies all the requirements for the LHCb Muon System

• We built a fast detector, with good time resolution and aging resistant

 It will cover an area of ~ 435 m<sup>2</sup> with 1380 chambers and ~126000 readout channels

• The production is started and the detector should be ready for the 1st LHC beams



### **Efficiency and crosstalk**



Crosstalk: probability of firing the neighboring pad

Pt accuracy measurement requires: Crosstalk < 5%

Main source is the pad-to-pad capacitive coupling

## **Chambers materials**

Common Materials: Gold plated 30 μm tungsten wires. Gold plated\_cathode pads. Adekit 145/450 epoxy for wire glueing.

**INFN chamber:** 

• Adekit 140 for chamber closing.

**CERN chambers**:

- Natural rubber O-rings.
- Kapton foils to protect HV-traces and glued with epoxy.
- Low temperature soldering, carbon film resistors and SMD capacitors.





## **RPC for LHCB Muon System**

#### **Historical review**

**1998: RPC were proposed for LHCb Muon detector** in regions with rates < 1 kHz/cm<sup>2</sup>.

1999: 2 prototypes built with identical characteristics:

- bakelite electrodes ( $\rho \sim 10^{10} \ \Omega \ cm$ );
- linseed oil;
- graphite ( 100 k $\Omega$ / );
- 50 x 50 cm<sup>2</sup> area.
- 2 mm gas gap ( $C_2H_2F_4$ :  $iC_4H_{10}$ :  $SF_6$  = 95:4:1)
- avalanche mode (HV ~10.6 kV).

2000: rate capability was measured to be ≥ 3 kHz/cm<sup>2</sup> (NIM A 456 (2000) 95.)

2001: an extensive test for study the aging properties started at GIF...

**Rates (kHz/cm<sup>2</sup>) and** integrated charge (C/cm<sup>2</sup>) for L = 5•10<sup>32</sup> cm<sup>-2</sup> s<sup>-1</sup>

	<b>M1</b>	M2	M3	<b>M4</b>	M5	
<b>R1</b>						
<b>R2</b>				R	RPC	
R3				0.75	0.65	
R4				0.25	0.23	

## Aging test in 2001 @ GIF



- **\* RPC** A irradiated at GIF during 7 months up to Q~ 0.4 C/cm<sup>2</sup>.
- \* RPC B not irradiated, used as reference.
- **♦** I, V<sub>0</sub> and T continuously monitored.
- Bakelite resistivity ρ extracted from (I,V<sub>0</sub>) curve using a model for RPC operating under high flux conditions
  (NIMA 498 (2003) 135) and corrected for T dependence.

### Aging test in 2001 @ GIF: RPC A results



#### Observed a steady increase of $\rho$ with and without irradiation.

### Aging test in 2002 @ GIF

- **\*** Both detectors slowly irradiated (Q~0.05 C/cm<sup>2</sup> accumulated charge).
- \* Resistivity continuously measured during ~ 350 days.
- \* Observed a steady increase of ρ with time for both deterctors probably due to drying up of bakelite.
- Addition of 1.2% of H<sub>2</sub>O vapor to the nominal gas mixture produced a decrease of resistivity. This effect in any case disappeared as soon as dry gas was flowed.



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### **Mechanical Tolerances:**

- The specifications for a single gap were defined such as the gas gain is within :
  - 0.8\*G<sub>0</sub> and 1.25\*G<sub>0</sub> in 95% of the chamber area;
  - $G_0/1.5$  and  $1.5*G_0$  in 5% of the chamber area.
- What chamber imperfections are allowed in order to keep the gain within specifications?

#### **SPECIFICATIONS:**

•	Gap:	95% in ± 90 μm	5% in ± 180 µm
•	Wire pitch:	95% in ± 50 μm	5% in ±100 µm
•	Wire y-offset:	95% in ±100 μm	5% in ±200 μm
•	Wire plane y-offset:	95% in $\pm$ 100 $\mu m$	5% in ± 200 μm

#### • The most critical parameter for our chambers is the gap dimension !!

### **Measurement of gain uniformity:**

-We scan each gap using a radioactive source (<sup>137</sup>Cs, 40 mCi, 0.66 MeV photons).

-The current drawn by group of wires is measured by a nano-amperometer with 1 nA resolution.





## **Average rates and Integrated Charges:**

	M1	M2	M3	M4	M5	]
	18/	15	4	2.6	1.76	kHz/cm <sup>2</sup>
<b>R1</b>	GEM	132 MWPC	35 MWPC	<b>46</b> MWPC	31 MWPC	mC/cm
	74.4	10.6	1.32	0.88	0.72	
R2	328	185	25	16	13	
	GEM or MWPC	MWPC	MWPC	MWPC	MWPC	
	32	2.6	0.4	0.3	0.26	
<b>R3</b>	141	46	7	6	5	
	MWPC	MWPC	MWPC	MWPC	MWPC	
	10	0.48	0.17	0.1	0.09	
<b>R4</b>	44	4.3	1.5	1	0.8	
	MWPC	MWPC	MWPC	MWPC	MWPC	

- Rates (TDR2000) and integrated charges in 10 equivalent (~  $10^8$  s) years for average luminosity  $\langle L \rangle = 2 \cdot 10^{32} \text{ cm}^{-2} \text{ s}^{-1}$ ,

- Safety factors (2 in M1 and 5 in M2-M5) are included.

### **Comparison with simulations**



Threshold (Fraction of average Signal in %)

- Comparison with simulations has been done by plotting double gap efficiency and time resolution as a function of threshold.
- The threshold is expressed as a fraction of the average signal in order to be independent from the gain.
- Full simulation:
  - primary ionization (HEED);
  - drift, diffusion (MAGBOLTZ);
  - induced signals (GARFIELD).

#### Good agreement between data and simulations

# **Comparison with ATLAS/CMS**

The ATLAS Cathode Strip Chambers are intended for position resolution. Amplifier peaking time 80ns, bipolar shaping, 'crosstalk intended' on cathode strips for center of gravity.

The CMS Cathode Strip Chambers are intended for position resolution (cathodes strips) and timing (wires). Cathode amplifier peaking time 100ns, wire amplifier peaking time 30ns.

The LHCb MWPCs are intended for highly efficient timing within a certain spatial granularity at the LVL0 trigger. Amplifier peaking time of 10ns, pulse width<50ns, unipolar shaping, low crosstalk.

Since crosstalk is  $\bigcirc R_{in}C_{pp}$  and since  $\leftarrow (\textcircled{O}20 \text{ MHz})$  is high we have to minimize the pad-pad capacitance  $C_{pp}$  and amplifier input impedance  $R_{in}$ . Because we want unipolar shaping we need a baseline restorer in the front end.

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